

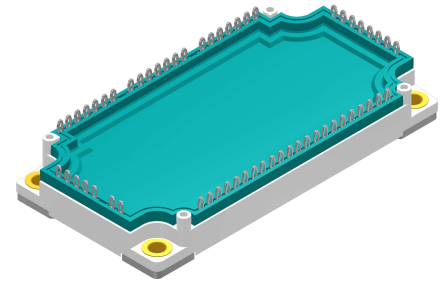
# High Voltage Standard Rectifier Module

<b>3~ Rectifier</b>
$V_{RRM} = 2200\text{ V}$
$I_{DAV} = 660\text{ A}$
$I_{FSM} = 5000\text{ A}$

3~ Rectifier Bridge + NTC

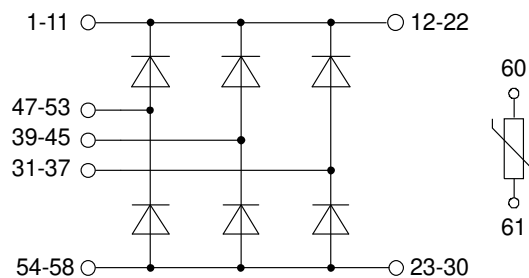
Part number

**MDNA660U2200PTEH**



Backside: isolated

 E72873



## Features / Advantages:

- Package with DCB ceramic
- Improved temperature and power cycling
- Planar passivated chips
- Very low forward voltage drop
- Very low leakage current

## Applications:

- Diode for main rectification
- For three phase bridge configurations
- Supplies for DC power equipment
- Input rectifiers for PWM inverter
- Battery DC power supplies
- Field supply for DC motors

## Package: E3-Pack

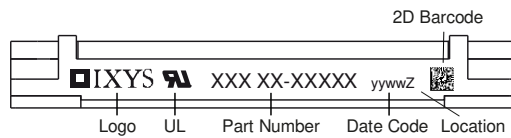
- Isolation Voltage: 4300 V~
- Industry standard outline
- RoHS compliant
- PressFit-Pins for PCB mounting
- Height: 17 mm
- Base plate: Copper internally DCB isolated
- Advanced power cycling
- Phase Change Material available

## Disclaimer Notice

Information furnished is believed to be accurate and reliable. However, users should independently evaluate the suitability of and test each product selected for their own applications. Littelfuse products are not designed for, and may not be used in, all applications. Read complete Disclaimer Notice at [www.littelfuse.com/disclaimer-electronics](http://www.littelfuse.com/disclaimer-electronics).

Rectifier				Ratings			
Symbol	Definition	Conditions		min.	typ.	max.	Unit
$V_{RSM}$	max. non-repetitive reverse blocking voltage			$T_{VJ} = 25^{\circ}C$		2300	V
$V_{RRM}$	max. repetitive reverse blocking voltage			$T_{VJ} = 25^{\circ}C$		2200	V
$I_R$	reverse current	$V_R = 2200\text{ V}$		$T_{VJ} = 25^{\circ}C$		400	$\mu A$
		$V_R = 2200\text{ V}$		$T_{VJ} = 150^{\circ}C$		6	mA
$V_F$	forward voltage drop	$I_F = 220\text{ A}$		$T_{VJ} = 25^{\circ}C$		1.28	V
		$I_F = 660\text{ A}$				1.95	V
		$I_F = 220\text{ A}$		$T_{VJ} = 125^{\circ}C$		1.19	V
		$I_F = 660\text{ A}$				1.95	V
$I_{DAV}$	bridge output current	$T_C = 85^{\circ}C$		$T_{VJ} = 150^{\circ}C$		660	A
		rectangular	$d = \frac{1}{3}$				
$V_{FO}$	threshold voltage			$T_{VJ} = 150^{\circ}C$		0.77	V
$r_F$	slope resistance					1.8	m $\Omega$
						} for power loss calculation only	
$R_{thJC}$	thermal resistance junction to case					0.15	K/W
$R_{thCH}$	thermal resistance case to heatsink				0.075		K/W
$P_{tot}$	total power dissipation			$T_C = 25^{\circ}C$		830	W
$I_{FSM}$	max. forward surge current	$t = 10\text{ ms}; (50\text{ Hz}), \text{ sine}$		$T_{VJ} = 45^{\circ}C$		5.00	kA
		$t = 8,3\text{ ms}; (60\text{ Hz}), \text{ sine}$		$V_R = 0\text{ V}$		5.40	kA
		$t = 10\text{ ms}; (50\text{ Hz}), \text{ sine}$		$T_{VJ} = 150^{\circ}C$		4.25	kA
		$t = 8,3\text{ ms}; (60\text{ Hz}), \text{ sine}$		$V_R = 0\text{ V}$		4.59	kA
$I^2t$	value for fusing	$t = 10\text{ ms}; (50\text{ Hz}), \text{ sine}$		$T_{VJ} = 45^{\circ}C$		125.0	kA <sup>2</sup> s
		$t = 8,3\text{ ms}; (60\text{ Hz}), \text{ sine}$		$V_R = 0\text{ V}$		121.3	kA <sup>2</sup> s
		$t = 10\text{ ms}; (50\text{ Hz}), \text{ sine}$		$T_{VJ} = 150^{\circ}C$		90.3	kA <sup>2</sup> s
		$t = 8,3\text{ ms}; (60\text{ Hz}), \text{ sine}$		$V_R = 0\text{ V}$		87.6	kA <sup>2</sup> s
$C_J$	junction capacitance	$V_R = 700\text{ V}; f = 1\text{ MHz}$		$T_{VJ} = 25^{\circ}C$		158	pF

Package E3-Pack		Ratings				
Symbol	Definition	Conditions	min.	typ.	max.	Unit
$I_{RMS}$	RMS current	per terminal			30	A
$T_{VJ}$	virtual junction temperature		-40		175	°C
$T_{op}$	operation temperature		-40		150	°C
$T_{stg}$	storage temperature		-40		125	°C
<b>Weight</b>				270		g
$M_D$	mounting torque		3		6	Nm
$d_{Spp/App}$	creepage distance on surface / striking distance through air	terminal to terminal	6.0			mm
$d_{Spb/Apb}$		terminal to backside	12.0			mm
$V_{ISOL}$	isolation voltage	t = 1 second t = 1 minute	4300 3600			V V
		50/60 Hz, RMS; $I_{ISOL} \leq 1$ mA				



### Part description

M = Module  
 D = Diode  
 N = High Voltage Standard Rectifier  
 A = ( $\geq 2000V$ )  
 660 = Current Rating [A]  
 U = 3- Rectifier Bridge  
 2200 = Reverse Voltage [V]  
 PT = PressFit-Pin, Thermistor  
 EH = E3-Pack  
 - = Hyphen  
 PC = Phase Change Material

Ordering	Ordering Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	MDNA660U2200PTEH	MDNA660U2200PTEH	Blister	24	516663
Alternative	MDNA660U2200PTEH-PC	MDNA660U2200PTEH	Blister	24	514482

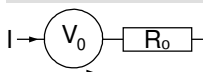
### Temperature Sensor NTC

Symbol	Definition	Conditions	min.	typ.	max.	Unit
$R_{25}$	resistance	$T_{VJ} = 25^\circ$	4.85	5	5.15	k $\Omega$
$B_{25/50}$	temperature coefficient			3375		K

### Equivalent Circuits for Simulation

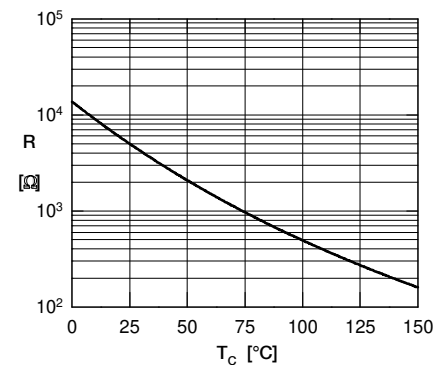
\* on die level

$T_{VJ} = 150^\circ C$



Rectifier

$V_{0\ max}$	threshold voltage	0.77				V
$R_{0\ max}$	slope resistance *	0.57				m $\Omega$





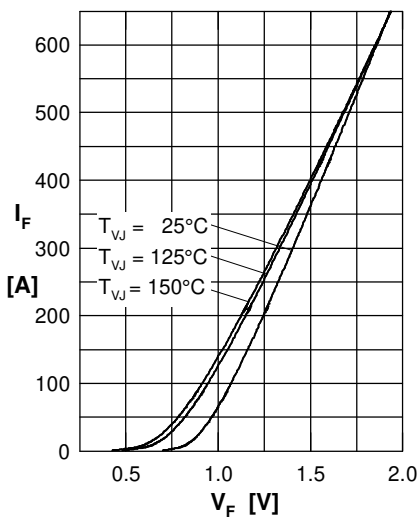
**Rectifier**


Fig. 1 Forward current versus voltage drop per diode

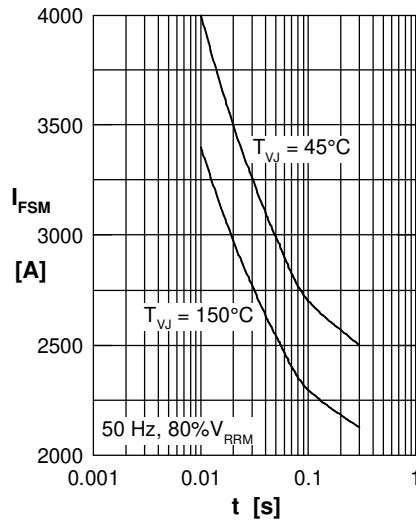


Fig. 2 Surge overload current vs. time per diode

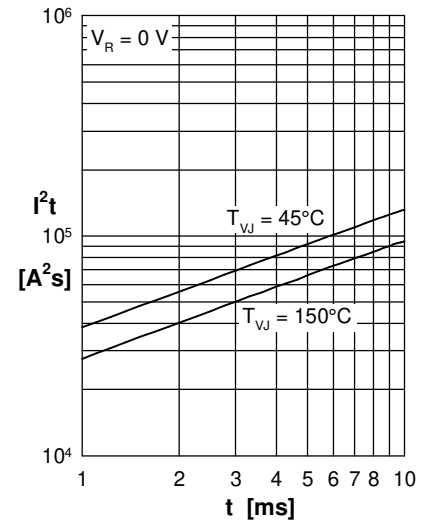
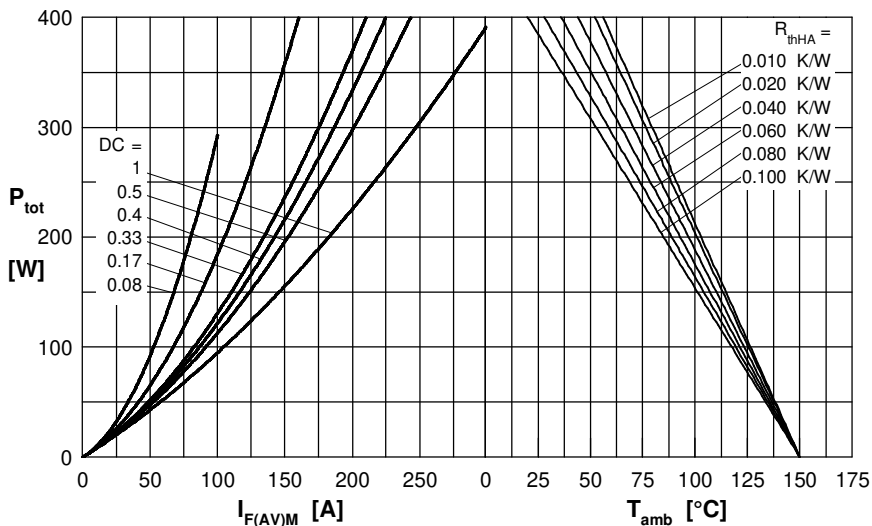

 Fig. 3  $I^2t$  versus time per diode


Fig. 4 Power dissipation vs. forward current and ambient temperature per diode

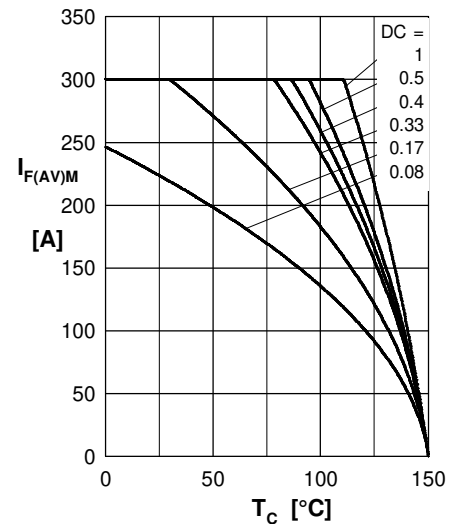


Fig. 5 Max. forward current vs. case temperature per diode

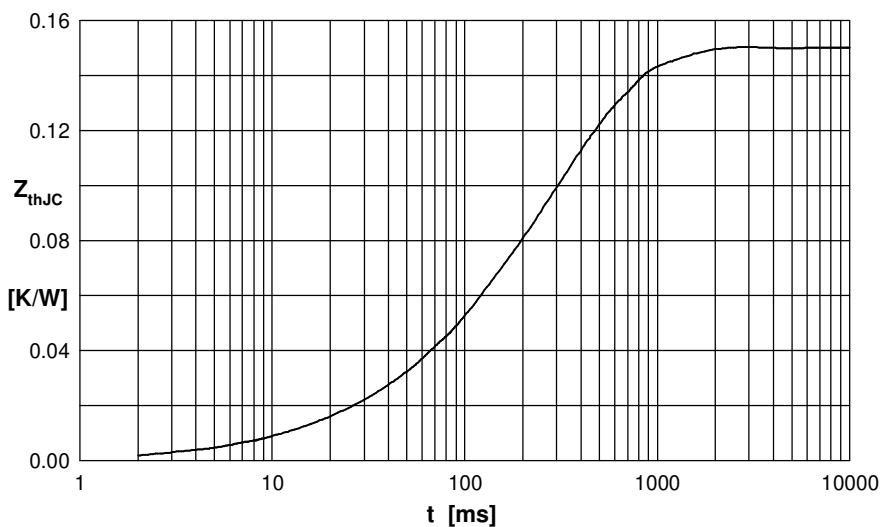


Fig. 6 Transient thermal impedance junction to case vs. time per diode

 Constants for  $Z_{thjC}$  calculation:

i	$R_{thi}$ (K/W)	$t_i$ (s)
1	0.006	0.015
2	0.017	0.080
3	0.039	0.220
4	0.088	0.380